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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	24MHz
Connectivity	CANbus, EBI/EMI, LINbus, SCI, UART/USART
Peripherals	DMA, POR, WDT
Number of I/O	82
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 16x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f342espmc-ge1

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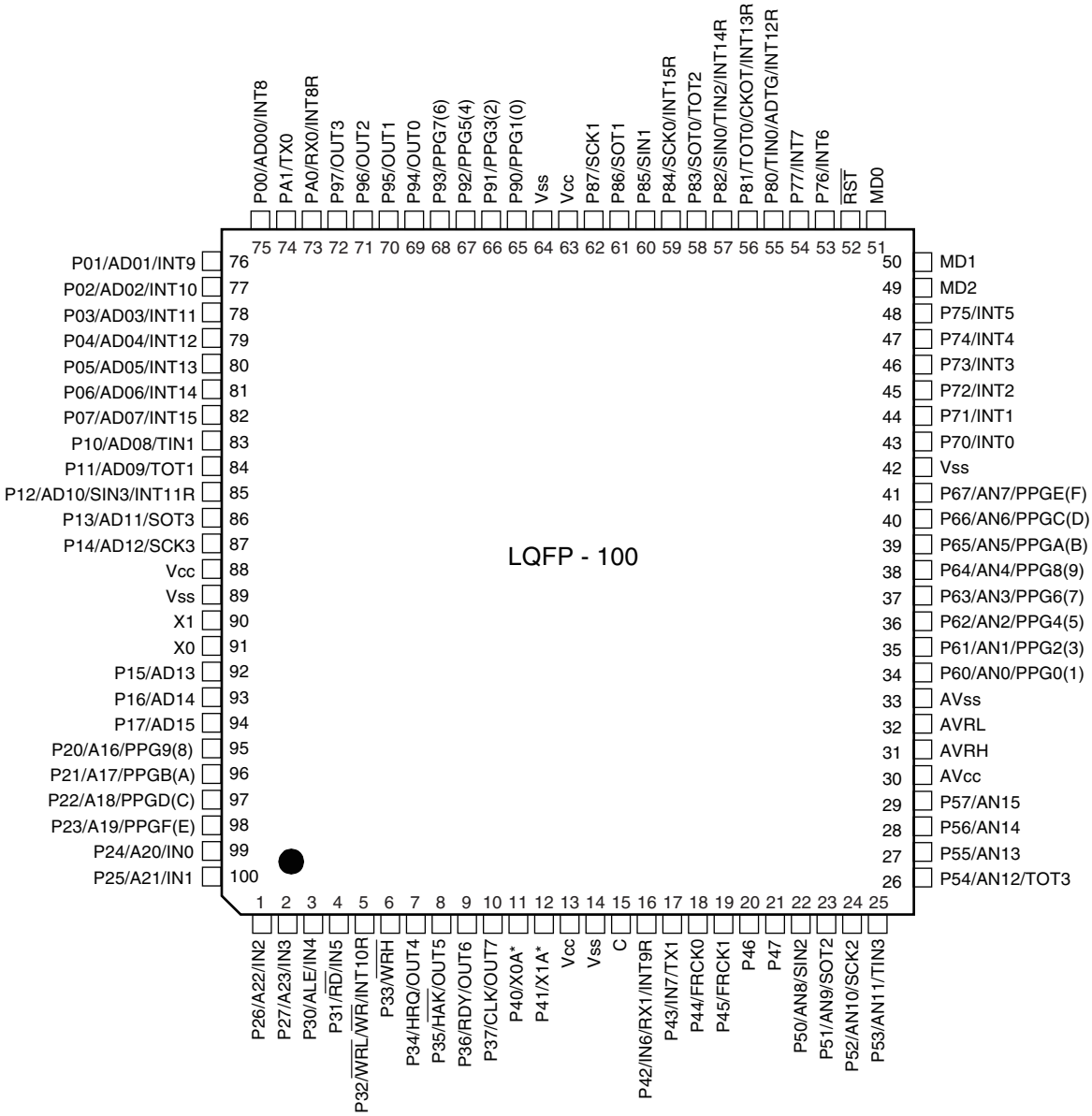
(TOP VIEW)



(FPT-100P-M20)

* : X0A, X1A : devices without an S suffix in the part number
P40, P4 : devices with an S suffix in the part number

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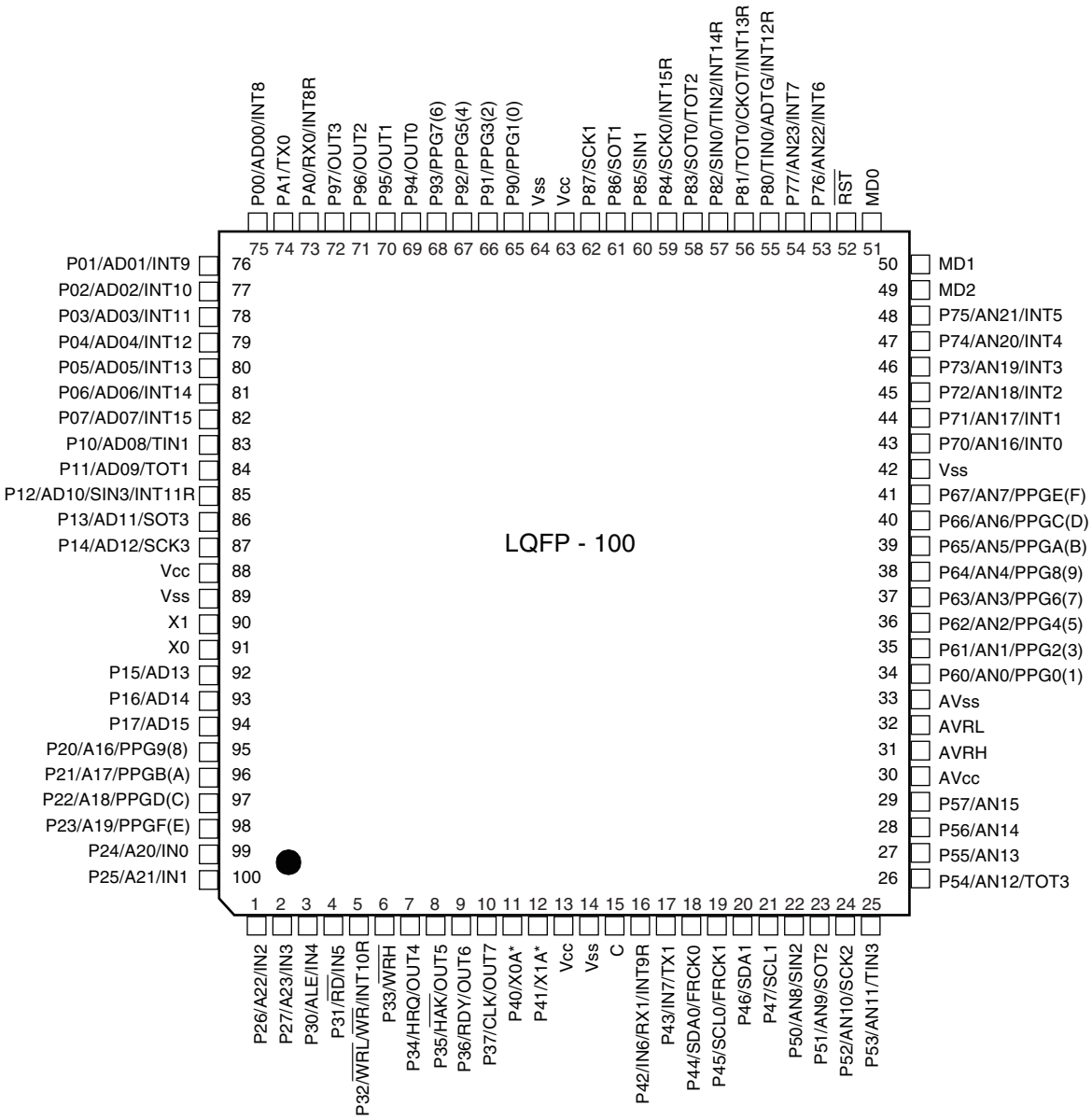
(TOP VIEW)



(FPT-100P-M20)

* : X0A, X1A : devices without an S suffix in the part number
P40, P41 : devices with an S suffix in the part number

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Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
96	94	P17	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD15		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
97 to 100	95 to 98	P20 to P23	G	General purpose I/O pins. The register can be set to select whether to use a pull-up resistor.In external bus mode, the pin is enabled as a general-purpose I/O port when the corresponding bit in the external address output control register (HACR) is 1.
		A16 to A19		Output pins of the external address bus. When the corresponding bit in the external address output control register (HACR) is 0, the pins are enabled as high address output pins (A16 to A19).
		PPG9,PPGB,PPGD,PPGF		Output pins for PPGs

1 : FPT-100P-M06

2 : FPT-100P-M20

3 : For I/O circuit type, refer to “I/O Circuit Type”.

5. Handling Devices

1. Preventing latch-up

CMOS IC may suffer latch-up under the following conditions:

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between V_{CC} and V_{SS} pins.
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current drastically, causing thermal damage to the device.

For the same reason, also be careful not to let the analog power-supply voltage (AV_{CC}, AVRH) exceed the digital power-supply voltage.

2. Handling unused pins

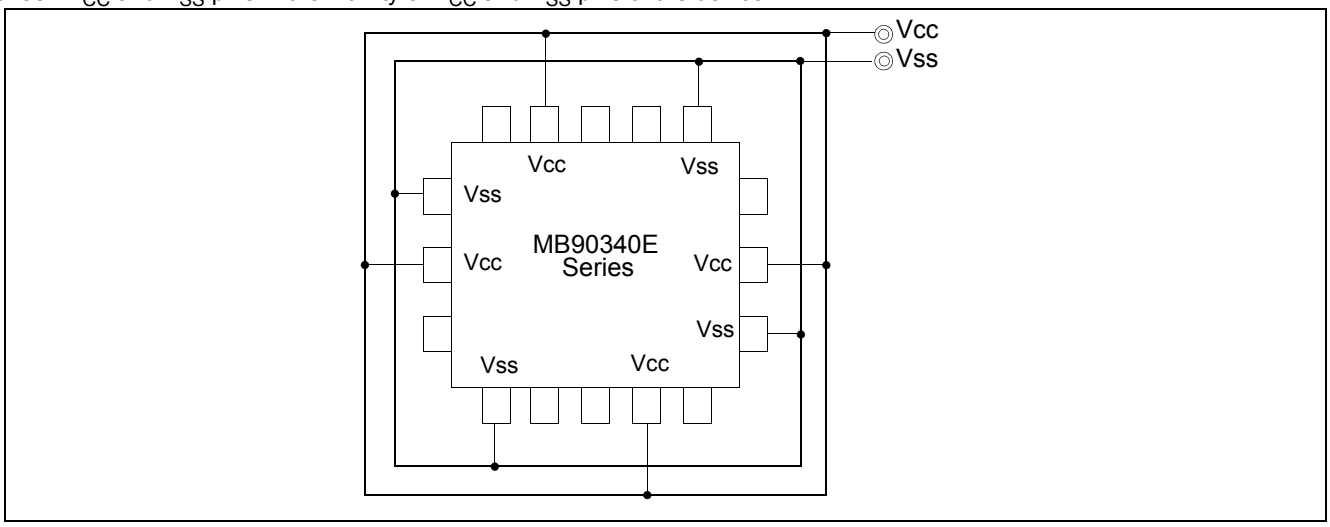
Leaving unused input terminals open may lead to permanent damage due to malfunction and latch-up; pull up or pull down the terminals through the resistors of 2 kΩ or more.

3. Power supply pins (V_{CC}/V_{SS})

- If there are multiple V_{CC} and V_{SS} pins, from the point of view of device design, pins to be of the same potential are connected inside of the device to prevent malfunction such as latch-up.

To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the V_{CC} and V_{SS} pins to the power supply and ground externally.
Connect V_{CC} and V_{SS} pins to the device from the current supply source at a possibly low impedance.

- As a measure against power supply noise, it is recommended to connect a capacitor of about 0.1 µF as a bypass capacitor between V_{CC} and V_{SS} pins in the vicinity of V_{CC} and V_{SS} pins of the device.

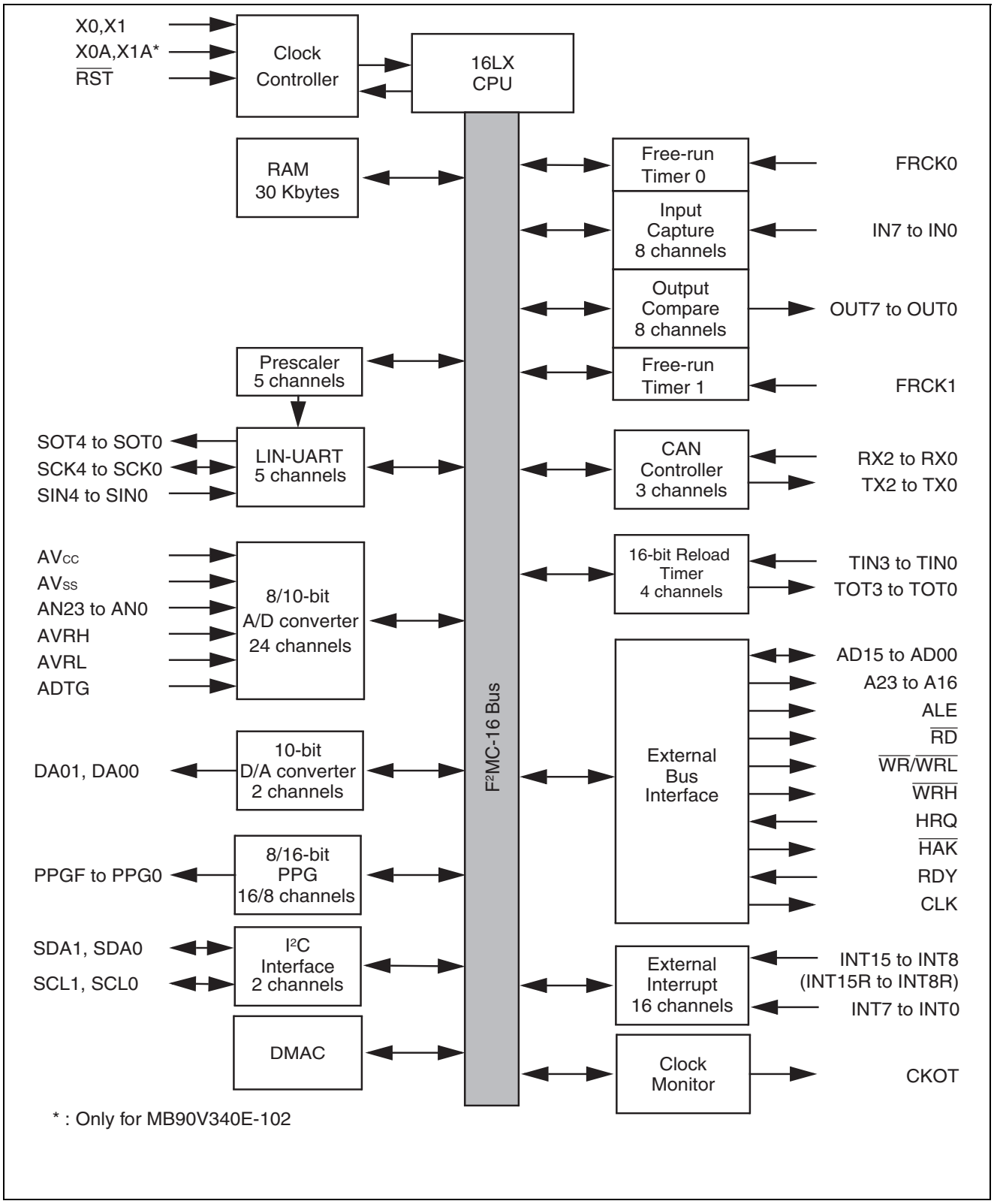


4. Mode Pins (MD0 to MD2)

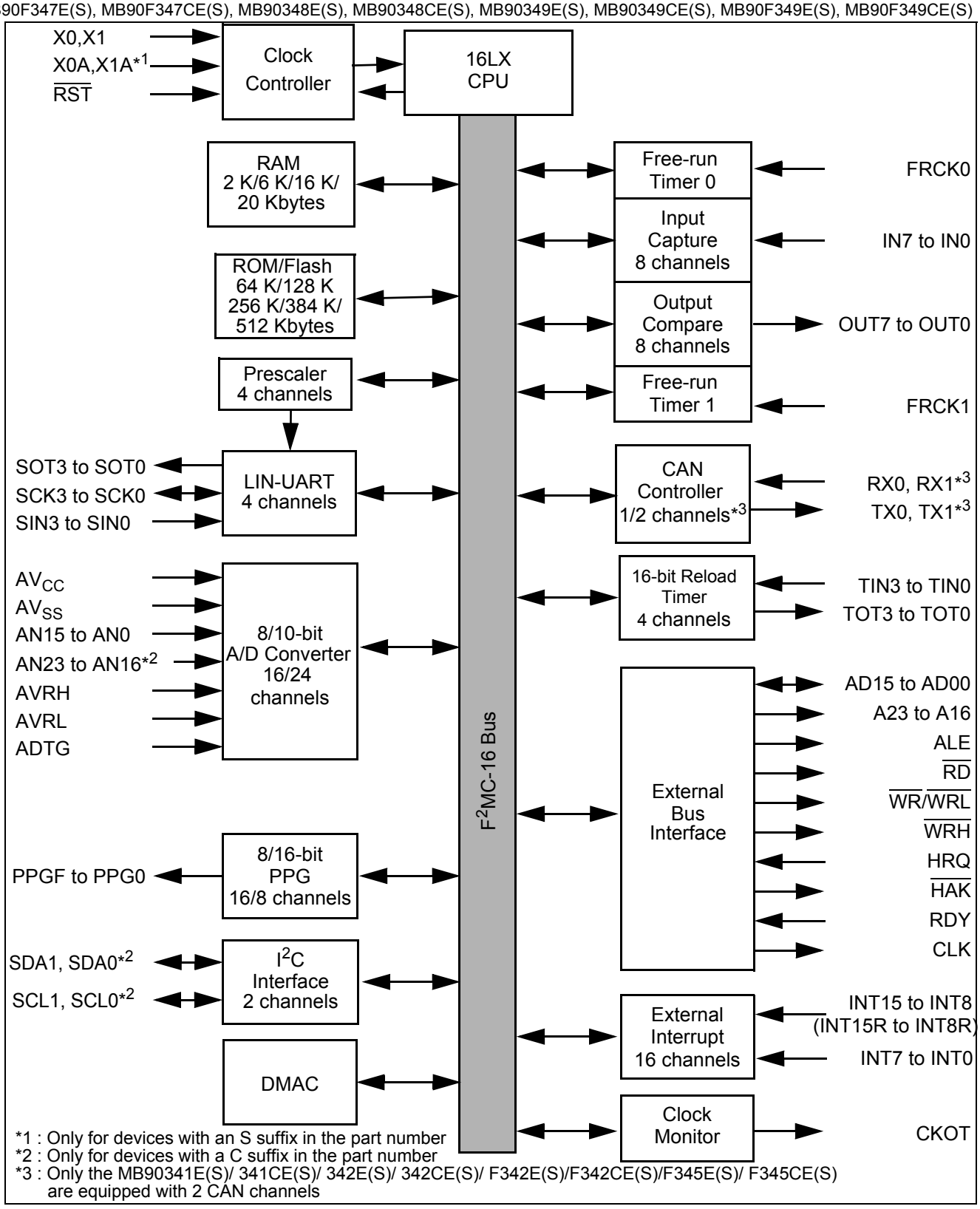
Connect the mode pins directly to V_{CC} or V_{SS} pins. To prevent the device unintentionally entering test mode due to noise, lay out the printed circuit board so as to minimize the distance from the mode pins to V_{CC} or V_{SS} pins and to provide a low-impedance connection.

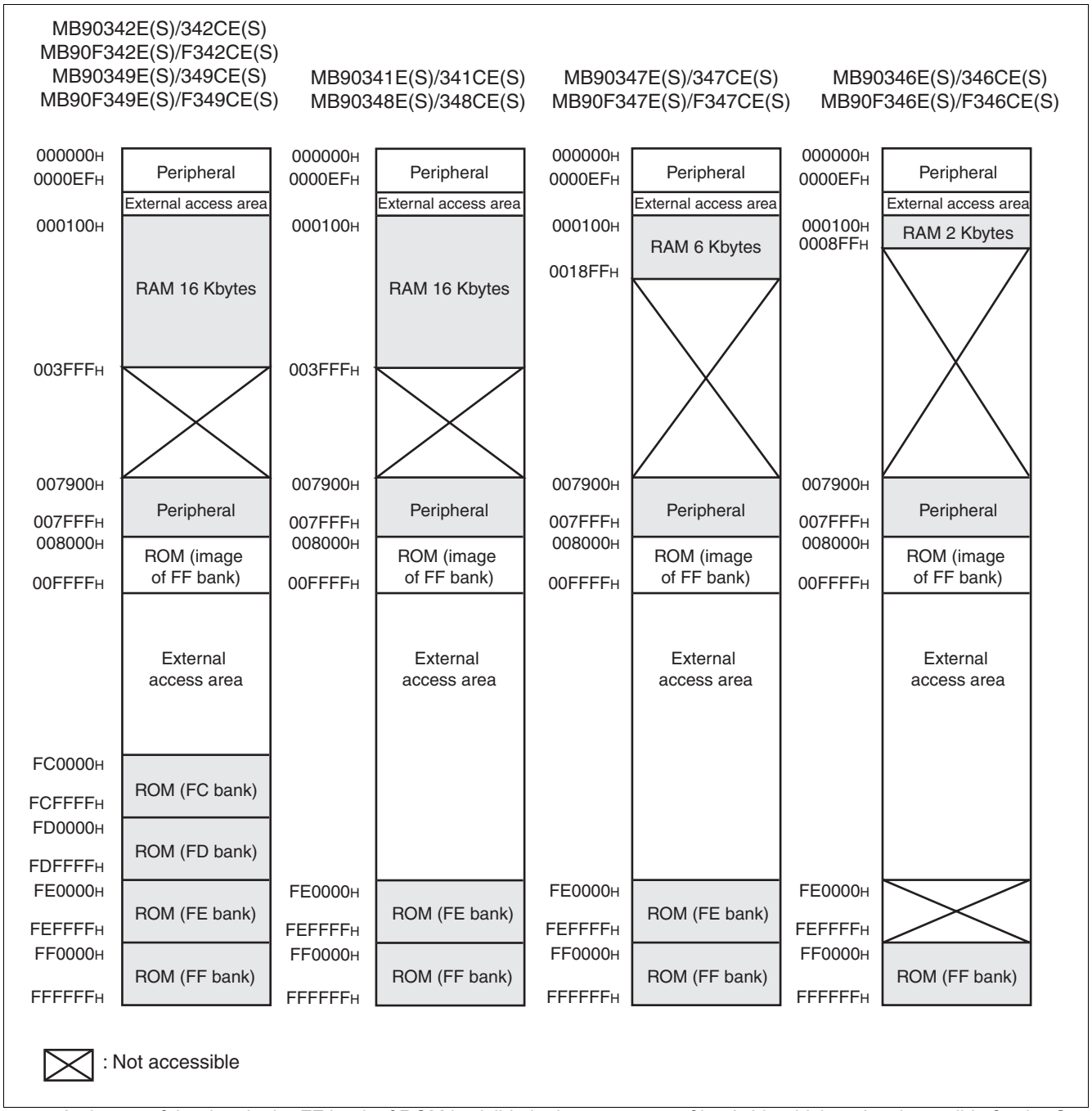
6. Block Diagrams

- MB90V340E-101/102



■ MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90346E(S), MB90346CE(S), MB90F346E(S), MB90F346CE(S), MB90347E(S), MB90347CE(S), MB90F347E(S), MB90F347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S), MB90F349E(S), MB90F349CE(S)





Note: :An image of the data in the FF bank of ROM is visible in the upper part of bank 00, which makes it possible for the C compiler to use the small memory model. The lower 16 bits of addresses in the FF bank are the same as the lower 16 bits of addresses in the 00 bank so that tables stored in the ROM can be accessed without using the far specifier in the pointer declaration.
For example, when the address $00C000_H$ is accessed, the data at $FFC000_H$ in ROM is actually accessed.
The ROM area in bank FF exceeds 32 Kbytes, and its entire image cannot be shown in bank 00.
As a result, the image between $FF8000_H$ and $FFFFFF_H$ is visible in bank 00, while the image between $FF0000_H$ and $FF7FFF_H$ is visible only in bank FF.

8. I/O Map

Address	Register	Abbreviation	Access	Resource name	Initial value
000000_H	Port 0 Data Register	PDR0	R/W	Port 0	$XXXXXXXX_B$
000001_H	Port 1 Data Register	PDR1	R/W	Port 1	$XXXXXXXX_B$
000002_H	Port 2 Data Register	PDR2	R/W	Port 2	$XXXXXXXX_B$
000003_H	Port 3 Data Register	PDR3	R/W	Port 3	$XXXXXXXX_B$
000004_H	Port 4 Data Register	PDR4	R/W	Port 4	$XXXXXXXX_B$
000005_H	Port 5 Data Register	PDR5	R/W	Port 5	$XXXXXXXX_B$
000006_H	Port 6 Data Register	PDR6	R/W	Port 6	$XXXXXXXX_B$
000007_H	Port 7 Data Register	PDR7	R/W	Port 7	$XXXXXXXX_B$
000008_H	Port 8 Data Register	PDR8	R/W	Port 8	$XXXXXXXX_B$
000009_H	Port 9 Data Register	PDR9	R/W	Port 9	$XXXXXXXX_B$
$00000A_H$	Port A Data Register	PDRA	R/W	Port A	$XXXXXXXX_B$
$00000B_H$	Port 5 Analog Input Enable Register	ADER5	R/W	Port 5, A/D	11111111_B
$00000C_H$	Port 6 Analog Input Enable Register	ADER6	R/W	Port 6, A/D	11111111_B
$00000D_H$	Port 7 Analog Input Enable Register	ADER7	R/W	Port 7, A/D	11111111_B
$00000E_H$	Input Level Select Register 0	ILSR0	R/W	Ports	$XXXXXXXX_B$
$00000F_H$	Input Level Select Register 1	ILSR1	R/W	Ports	$XXXX0XXX_B$
000010_H	Port 0 Direction Register	DDR0	R/W	Port 0	00000000_B
000011_H	Port 1 Direction Register	DDR1	R/W	Port 1	00000000_B
000012_H	Port 2 Direction Register	DDR2	R/W	Port 2	00000000_B
000013_H	Port 3 Direction Register	DDR3	R/W	Port 3	00000000_B
000014_H	Port 4 Direction Register	DDR4	R/W	Port 4	00000000_B
000015_H	Port 5 Direction Register	DDR5	R/W	Port 5	00000000_B
000016_H	Port 6 Direction Register	DDR6	R/W	Port 6	00000000_B
000017_H	Port 7 Direction Register	DDR7	R/W	Port 7	00000000_B
000018_H	Port 8 Direction Register	DDR8	R/W	Port 8	00000000_B
000019_H	Port 9 Direction Register	DDR9	R/W	Port 9	00000000_B
$00001A_H$	Port A Direction Register	DDRA	R/W	Port A	00000100_B
$00001B_H$	Reserved				
$00001C_H$	Port 0 Pull-up Control Register	PUCR0	R/W	Port 0	00000000_B
$00001D_H$	Port 1 Pull-up Control Register	PUCR1	R/W	Port 1	00000000_B
$00001E_H$	Port 2 Pull-up Control Register	PUCR2	R/W	Port 2	00000000_B
$00001F_H$	Port 3 Pull-up Control Register	PUCR3	W, R/W	Port 3	00000000_B

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
000060_H	Timer Control Status 0	TMCSR0	R/W	16-bit Reload Timer 0	00000000_B
000061_H	Timer Control Status 0	TMCSR0	R/W		$XXXX0000_B$
000062_H	Timer Control Status 1	TMCSR1	R/W	16-bit Reload Timer 1	00000000_B
000063_H	Timer Control Status 1	TMCSR1	R/W		$XXXX0000_B$
000064_H	Timer Control Status 2	TMCSR2	R/W	16-bit Reload Timer 2	00000000_B
000065_H	Timer Control Status 2	TMCSR2	R/W		$XXXX0000_B$
000066_H	Timer Control Status 3	TMCSR3	R/W	16-bit Reload Timer 3	00000000_B
000067_H	Timer Control Status 3	TMCSR3	R/W		$XXXX0000_B$
000068_H	A/D Control Status 0	ADCS0	R/W	A/D Converter	$000XXXX0_B$
000069_H	A/D Control Status 1	ADCS1	R/W		$0000000X_B$
$00006A_H$	A/D Data 0	ADCR0	R		00000000_B
$00006B_H$	A/D Data 1	ADCR1	R		$XXXXXX00_B$
$00006C_H$	ADC Setting 0	ADSR0	R/W		00000000_B
$00006D_H$	ADC Setting 1	ADSR1	R/W		00000000_B
$00006E_H$	Reserved				
$00006F_H$	ROM Mirror Function Select	ROMM	W	ROM Mirror	$XXXXXXX1_B$
000070_H to $00008F_H$	Reserved for CAN Controller 0/1. Refer to "CAN Controllers"				
000090_H to $00009A_H$	Reserved				
$00009B_H$	DMA Descriptor Channel Specified Register	DCSR	R/W	DMA	00000000_B
$00009C_H$	DMA Status L Register	DSRL	R/W		00000000_B
$00009D_H$	DMA Status H Register	DSRH	R/W		00000000_B
$00009E_H$	Address Detect Control Register 0	PACSR0	R/W	Address Match Detection 0	00000000_B
$00009F_H$	Delayed Interrupt Trigger/Release Register	DIRR	R/W	Delayed Interrupt	$XXXXXXX0_B$
$0000A0_H$	Low-power Mode Control Register	LPMCR	W,R/W	Low Power Control Circuit	00011000_B
$0000A1_H$	Clock Selection Register	CKSCR	R,R/W	Low Power Control Circuit	11111100_B
$0000A2_H$, $0000A3_H$	Reserved				
$0000A4_H$	DMA Stop Status Register	DSSR	R/W	DMA	00000000_B

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
007948_H	Timer 0/Reload 0	TMR0/TMRLR0	R/W	16-bit Reload Timer 0	$XXXXXXXX_B$
007949_H			R/W		$XXXXXXXX_B$
$00794A_H$	Timer 1/Reload 1	TMR1/TMRLR1	R/W	16-bit Reload Timer 1	$XXXXXXXX_B$
$00794B_H$			R/W		$XXXXXXXX_B$
$00794C_H$	Timer 2/Reload 2	TMR2/TMRLR2	R/W	16-bit Reload Timer 2	$XXXXXXXX_B$
$00794D_H$			R/W		$XXXXXXXX_B$
$00794E_H$	Timer 3/Reload 3	TMR3/TMRLR3	R/W	16-bit Reload Timer 3	$XXXXXXXX_B$
$00794F_H$			R/W		$XXXXXXXX_B$
007950_H	Serial Mode Register 3	SMR3	W,R/W	UART3	00000000_B
007951_H	Serial Control Register 3	SCR3	W,R/W		00000000_B
007952_H	Reception/Transmission Data Register 3	RDR3/TDR3	R/W		00000000_B
007953_H	Serial Status Register 3	SSR3	R,R/W		00001000_B
007954_H	Extended Communication Control Register 3	ECCR3	R,W, R/W		$000000XX_B$
007955_H	Extended Status Control Register	ESCR3	R/W		00000100_B
007956_H	Baud Rate Generator Register 30	BGR30	R/W		00000000_B
007957_H	Baud Rate Generator Register 31	BGR31	R/W		00000000_B
007958_H	Serial Mode Register 4	SMR4	W,R/W	UART4	00000000_B
007959_H	Serial Control Register 4	SCR4	W,R/W		00000000_B
$00795A_H$	Reception/Transmission Data Register 4	RDR4/TDR4	R/W		00000000_B
$00795B_H$	Serial Status Register 4	SSR4	R,R/W		00001000_B
$00795C_H$	Extended Communication Control Register 4	ECCR4	R,W, R/W		$000000XX_B$
$00795D_H$	Extended Status Control Register	ESCR4	R/W		00000100_B
$00795E_H$	Baud Rate Generator Register 40	BGR40	R/W		00000000_B
$00795F_H$	Baud Rate Generator Register 41	BGR41	R/W		00000000_B
007960_H to $00796B_H$	Reserved				
$00796C_H$	Clock Output Enable Register	CLKR	R/W	Clock Monitor	$XXXX0000_B$
$00796D_H$	Reserved				
$00796E_H$	CAN Direct Mode Register	CDMR	R/W	CAN Clock sync	$XXXXXXX0_B$
$00796F_H$	CAN Switch Register	CANSWR	R/W	CAN 0/1	$XXXXXX00_B$

(Continued)

List of Message Buffers (ID Registers) (2)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007A40_H$	$007C40_H$	ID Register 8	IDR8	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A41_H$	$007C41_H$				
$007A42_H$	$007C42_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A43_H$	$007C43_H$				
$007A44_H$	$007C44_H$	ID Register 9	IDR9	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A45_H$	$007C45_H$				
$007A46_H$	$007C46_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A47_H$	$007C47_H$				
$007A48_H$	$007C48_H$	ID Register 10	IDR10	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A49_H$	$007C49_H$				
$007A4A_H$	$007C4A_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A4B_H$	$007C4B_H$				
$007A4C_H$	$007C4C_H$	ID Register 11	IDR11	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A4D_H$	$007C4D_H$				
$007A4E_H$	$007C4E_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A4F_H$	$007C4F_H$				
$007A50_H$	$007C50_H$	ID Register 12	IDR12	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A51_H$	$007C51_H$				
$007A52_H$	$007C52_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A53_H$	$007C53_H$				
$007A54_H$	$007C54_H$	ID Register 13	IDR13	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A55_H$	$007C55_H$				
$007A56_H$	$007C56_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A57_H$	$007C57_H$				
$007A58_H$	$007C58_H$	ID Register 14	IDR14	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A59_H$	$007C59_H$				
$007A5A_H$	$007C5A_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A5B_H$	$007C5B_H$				
$007A5C_H$	$007C5C_H$	ID Register 15	IDR15	R/W	$XXXXXXXX_B$ $XXXXXXXX_B$
$007A5D_H$	$007C5D_H$				
$007A5E_H$	$007C5E_H$				$XXXXXXXX_B$ $XXXXXXXX_B$
$007A5F_H$	$007C5F_H$				

List of Message Buffers (DLC Registers and Data Registers) (3)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
$007AF0_H$ to $007AF7_H$	$007CF0_H$ to $007CF7_H$	Data Register 14 (8 bytes)	DTR14	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$
$007AF8_H$ to $007AFF_H$	$007CF8_H$ to $007CFF_H$	Data Register 15 (8 bytes)	DTR15	R/W	$XXXXXXXX_B$ to $XXXXXXXX_B$

10. Interrupt Factors, Interrupt Vectors, Interrupt Control Register

Interrupt cause	EI^{2}OS Support	DMA channel number	Interrupt vector		Interrupt control register	
			Number	Address	Number	Address
Reset	N	—	#08	FFFFDC$_H$	—	—
INT9 instruction	N	—	#09	FFFFD8$_H$	—	—
Exception	N	—	#10	FFFFD4$_H$	—	—
CAN 0 RX	N	—	#11	FFFFD0$_H$	ICR00	0000B0$_H$
CAN 0 TX/NS	N	—	#12	FFFFCC$_H$		
CAN 1 RX / Input Capture 6	Y1	—	#13	FFFFC8$_H$	ICR01	0000B1$_H$
CAN 1 TX/NS / Input Capture 7	Y1	—	#14	FFFFC4$_H$		
CAN 2 RX / I^{2}C0	N	—	#15	FFFFC0$_H$	ICR02	0000B2$_H$
CAN 2 TX/NS	N	—	#16	FFFFBC$_H$		
16-bit Reload Timer 0	Y1	0	#17	FFFFB8$_H$	ICR03	0000B3$_H$
16-bit Reload Timer 1	Y1	1	#18	FFFFB4$_H$		
16-bit Reload Timer 2	Y1	2	#19	FFFFB0$_H$	ICR04	0000B4$_H$
16-bit Reload Timer 3	Y1	—	#20	FFFFAC$_H$		
PPG 0/1/4/5	N	—	#21	FFFFA8$_H$	ICR05	0000B5$_H$
PPG 2/3/6/7	N	—	#22	FFFFA4$_H$		
PPG 8/9/C/D	N	—	#23	FFFFA0$_H$	ICR06	0000B6$_H$
PPG A/B/E/F	N	—	#24	FFFF9C$_H$		
Time Base Timer	N	—	#25	FFFF98$_H$	ICR07	0000B7$_H$
External Interrupt 0 to 3, 8 to 11	Y1	3	#26	FFFF94$_H$		
Watch Timer	N	—	#27	FFFF90$_H$	ICR08	0000B8$_H$
External Interrupt 4 to 7, 12 to 15	Y1	4	#28	FFFF8C$_H$		
A/D Converter	Y1	5	#29	FFFF88$_H$	ICR09	0000B9$_H$
Free-run Timer 0 / Free-run Timer 1	N	—	#30	FFFF84$_H$		
Input Capture 4/5 / I^{2}C1	Y1	6	#31	FFFF80$_H$	ICR10	0000BA$_H$
Output Compare 0/1/4/5	Y1	7	#32	FFFF7C$_H$		
Input Capture 0 to 3	Y1	8	#33	FFFF78$_H$	ICR11	0000BB$_H$
Output Compare 2/3/6/7	Y1	9	#34	FFFF74$_H$		
UART 0 RX	Y2	10	#35	FFFF70$_H$	ICR12	0000BC$_H$
UART 0 TX	Y1	11	#36	FFFF6C$_H$		
UART 1 RX / UART 3 RX	Y2	12	#37	FFFF68$_H$	ICR13	0000BD$_H$
UART 1 TX / UART 3 TX	Y1	13	#38	FFFF64$_H$		

(Continued)

11. Electrical Characteristics

11.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
	AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_{CC} = AV_{CC}$*2
	AVRH, AVRL	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$AV_{CC} \geq$ AVRH, $AV_{CC} \geq$ AVRL, AVRH $\geq$ AVRL
Input voltage*1	V_I	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Output voltage*1	V_O	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*3
Maximum Clamp Current	I_{CLAMP}	−4.0	+4.0	mA	*5
Total Maximum Clamp Current	$\Sigma\lvert I_{CLAMP}\rvert$	—	40	mA	*5
“L” level maximum output current	I_{OL}	—	15	mA	*4, *6
“L” level average output current	I_{OLAV}	—	4	mA	*4, *7
“L” level maximum overall output current	ΣI_{OL}	—	100	mA	*4
“L” level average overall output current	ΣI_{OLAV}	—	50	mA	*4, *8
“H” level maximum output current	I_{OH}	—	−15	mA	*4, *6
“H” level average output current	I_{OHAV}	—	−4	mA	*4, *7
“H” level maximum overall output current	ΣI_{OH}	—	−100	mA	*4
“H” level average overall output current	ΣI_{OHAV}	—	−50	mA	*4, *8
Power consumption	P_D	—	450	mW	
Operating temperature	T_A	−40	+105	°C	
Storage temperature	T_{STG}	−55	+150	°C	

*1: This parameter is based on $V_{SS} = AV_{SS} = 0$ V

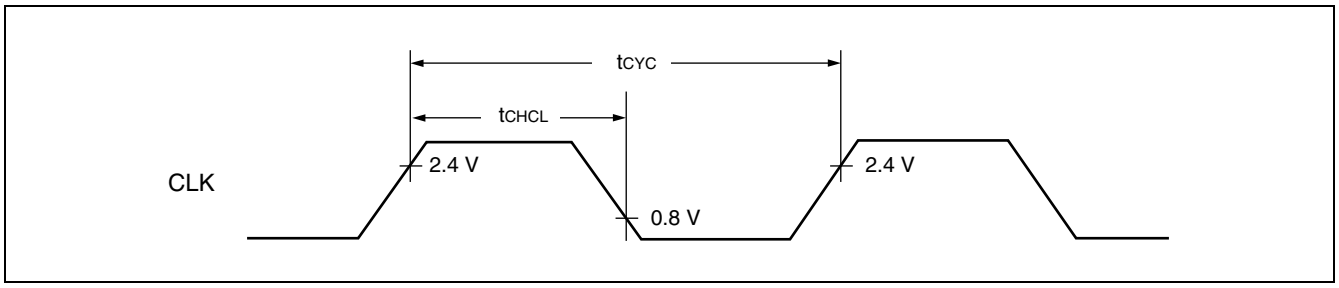
*2: Set AV_{CC} and V_{CC} to the same voltage. Make sure that AV_{CC} does not exceed V_{CC} and that the voltage at the analog inputs does not exceed AV_{CC} when the power is switched on.

*3: V_I and V_O should not exceed $V_{CC} + 0.3$ V. V_I should not exceed the specified ratings. However if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supersedes the V_I rating.

*4: Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0, PA1

*5:
- Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57 (Evaluation device : P50 to P55) , P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0 to PA1
- Use within recommended operating conditions.
- Use with DC voltage (current)
- The +B signal should always be applied by using a limiting resistance placed between the +B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the +B signal is applied, the input current to the microcontroller pin does not exceed the rated value, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.

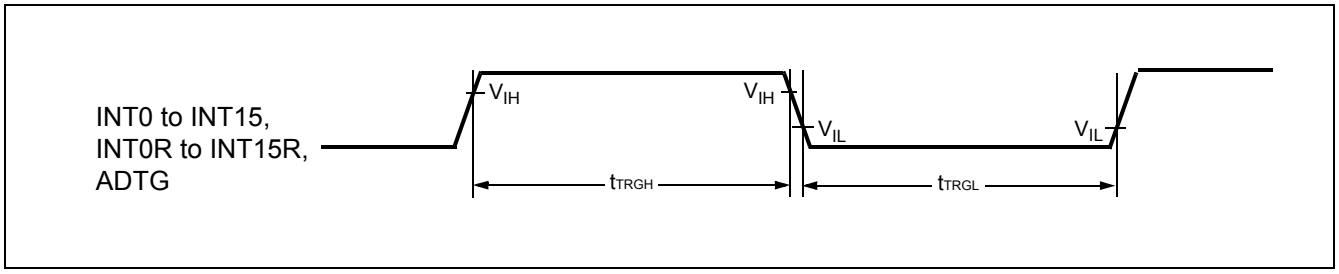
(Continued)


tCYC
tCHCL
CLK
2.4 V
2.4 V
0.8 V

11.4.10 Trigger Input Timing

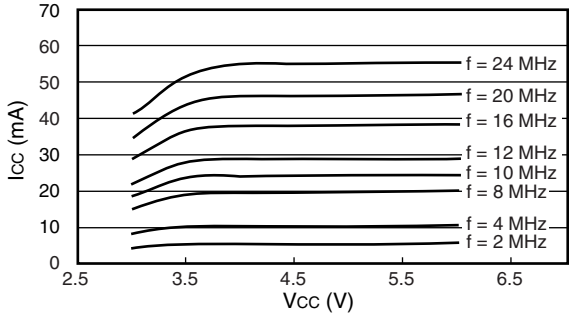
(T_A = −40°C to +105°C, V_{CC} = 5.0 V ± 10%, f_{CP} ≤ 24 MHz, V_{SS} = 0.0 V)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Input pulse width	t_{TRGH} t_{TRGL}	INT0 to INT15, INT0R to INT15R, ADTG	—	5 t_{CP}	—	ns

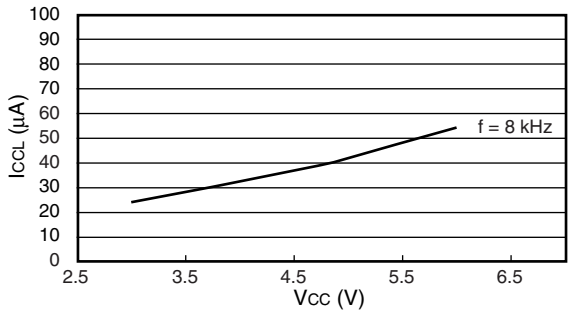


■ MB90347E, MB90347ES, MB90347CE, MB90347CES

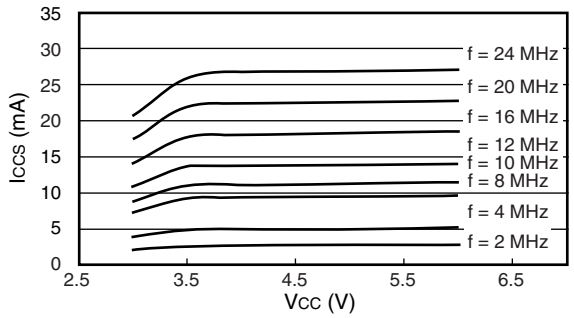
$I_{CC} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



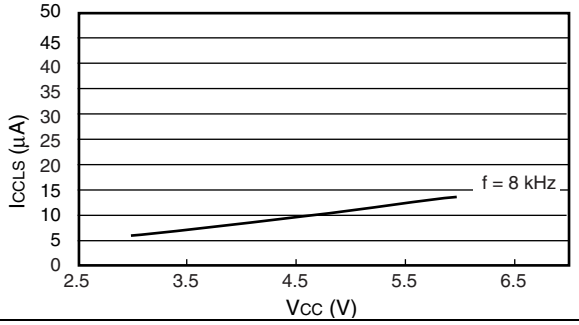
$I_{CCL} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



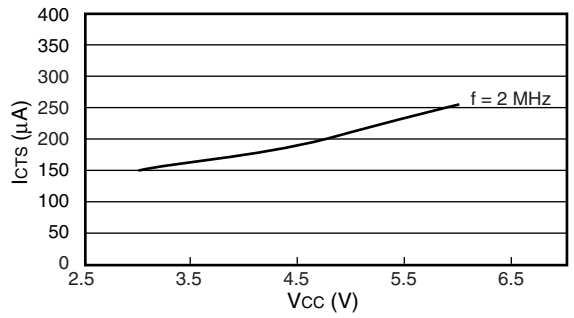
$I_{CCS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



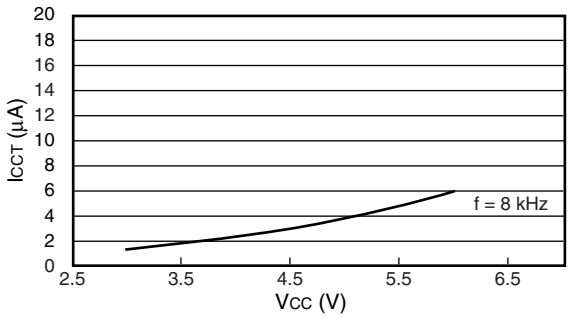
$I_{CCLS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



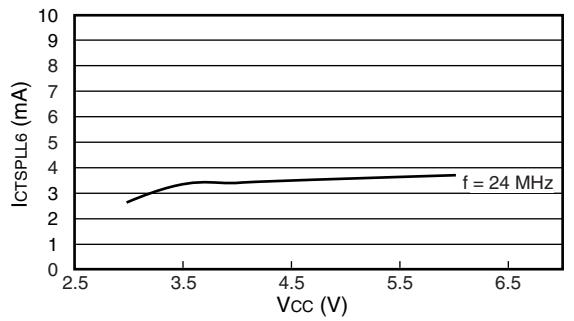
$I_{CTS} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



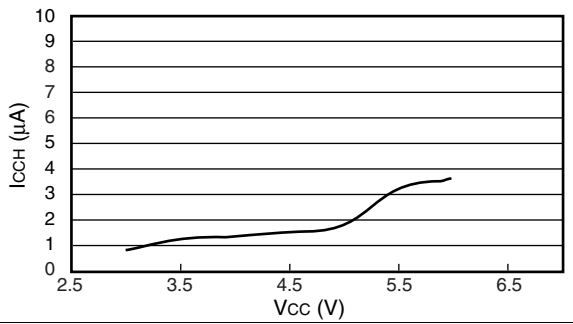
$I_{CCT} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
$T_A = +25°C$, external clock operation f = Internal operation frequency

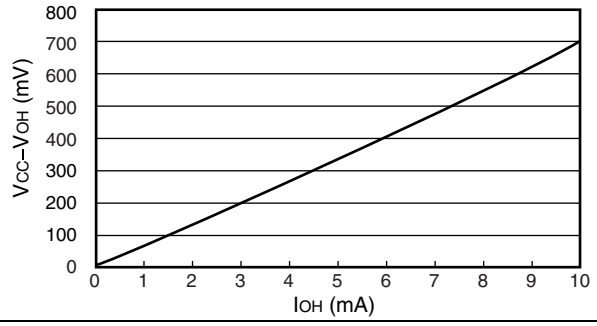


$I_{CCH} - V_{CC}$
$T_A = +25°C$, stopped

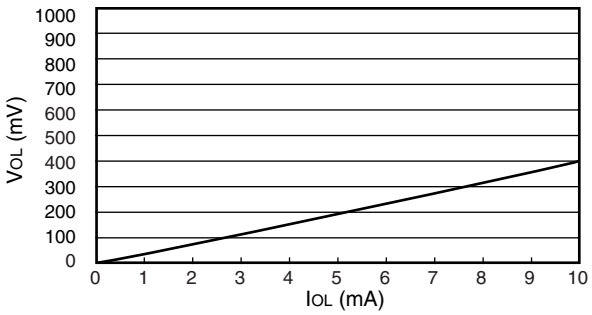


■ I/O characteristics

$(V_{CC}-V_{OH})$ – I_{OH}
T_A = +25°C, V_{CC} = 4.5 V

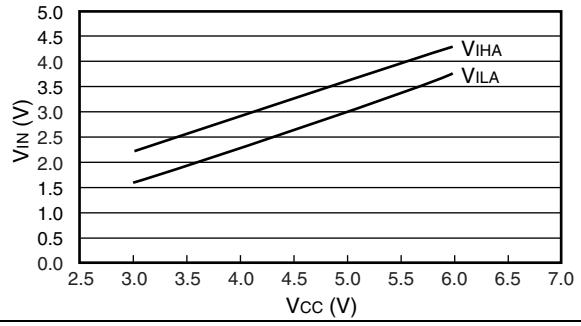


V_{OL} – I_{OL}
T_A = +25°C, V_{CC} = 4.5 V

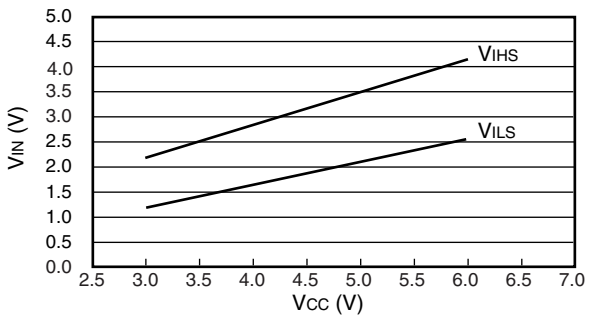


Automotive V_{IN} – V_{CC}

T_A = +25°C

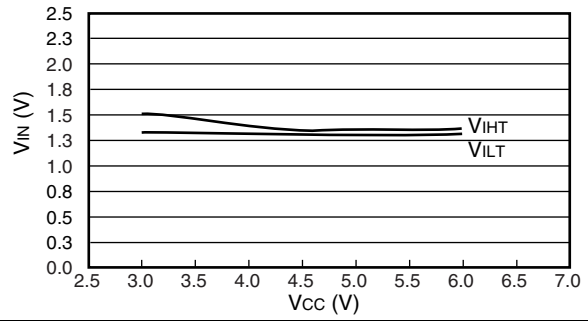


CMOS V_{IN} – V_{CC}
Other than UART-SIN pin and I^2C pin
T_A = +25°C

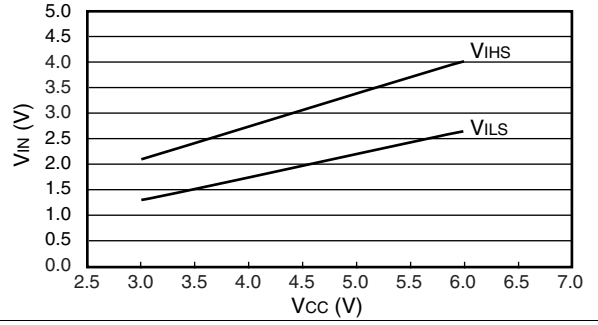


TTL V_{IN} – V_{CC}

T_A = +25°C



CMOS V_{IN} – V_{CC}
UART-SIN pin, I^2C pin
T_A = +25°C



Part number	Package	Remarks
MB90F347EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F347ESPF		
MB90F347CEPF		
MB90F347CESPF		
MB90F347EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F347ESPMC		
MB90F347CEPMC		
MB90F347CESPMC		
MB90F349EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F349ESPF		
MB90F349CEPF		
MB90F349CESPF		
MB90F349EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F349ESPMC		
MB90F349CEPMC		
MB90F349CESPMC		
MB90341EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90341ESPF		
MB90341CEPF		
MB90341CESPF		
MB90341EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90341ESPMC		
MB90341CEPMC		
MB90341CESPMC		
MB90342EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90342ESPF		
MB90342CEPF		
MB90342CESPF		
MB90342EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90342ESPMC		
MB90342CEPMC		
MB90342CESPMC		

(Continued)

15. Major Changes

Spansiion Publication Number: DS07-13747-4E

Page	Section	Change Results
___	___	Deleted the part numbers; MB90F343E(S), MB90F343CE(S)
51	Electrical Characteristics Absolute Maximum Ratings	Added “*6” in remark for “L" level maximum output current and “H” level maximum output current. Added “*7” in remark for “L" level average output current and “H” level average output current. Added “*8” in remark for “L"level average overall output current and “H” level average overall output current.
52		Added as follows. “*6:The maximum output current is defined as the peak value of the current of any one of the corresponding pins.” “*7:The average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.” “*8:The average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.”

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: MB90340E Series F2MC-16LX 16-bit Microcontroller Datasheet Document Number: 002-04498				
Revision	**ECN**	**Orig. of Change**	**Submission Date**	**Description of Change**
**	—	AKIH	08/23/2010	Migrated to Cypress and assigned document number 002-04498. No change to document contents or format.
*A	5221535	AKIH	05/04/2016	Updated to Cypress template